# DISCRETE SEMICONDUCTORS

# DATA SHEET

# BFQ68 NPN 4 GHz wideband transistor

Product specification
File under Discrete Semiconductors, SC14

September 1995





BFQ68

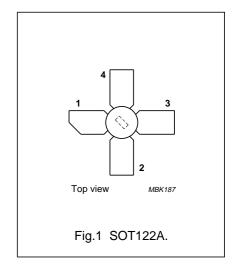
#### **DESCRIPTION**

NPN transistor mounted in a four-lead dual-emitter SOT122A envelope with a ceramic cap. All leads are isolated from the stud. Diffused emitter-ballasting resistors and the application of gold sandwich metallization ensure an optimum temperature profile and excellent reliability properties. It features very high output voltage capabilities.

It is primarily intended for final stages in MATV system amplifiers, and is also suitable for use in low power band IV and V equipment.

#### **PINNING**

PIN	DESCRIPTION
1	collector
2	emitter
3	base
4	emitter



#### **QUICK REFERENCE DATA**

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
V <sub>CEO</sub>	collector-emitter voltage	open base	_	18	٧
I <sub>C</sub>	collector current		_	300	mA
P <sub>tot</sub>	total power dissipation	up to T <sub>c</sub> = 110 °C	_	4.5	W
f <sub>T</sub>	transition frequency	$I_C$ = 240 mA; $V_{CE}$ = 15 V; f = 500 MHz; $T_j$ = 25 °C	4	_	GHz
Vo	output voltage	$I_c$ = 240 mA; $V_{CE}$ = 15 V; $d_{im}$ = -60 dB; $R_L$ = 75 Ω; $f_{(p+q-r)}$ = 793.25 MHz; $T_{amb}$ = 25 °C	1.6	_	V
P <sub>L1</sub>	output power at 1 dB gain compression	$I_c = 240 \text{ mA}; V_{CE} = 15 \text{ V}; R_L = 75 \Omega;$ $f = 800 \text{ MHz}; T_{amb} = 25 ^{\circ}\text{C}$	28	_	dBm
ITO	third order intercept point	$I_c$ = 240 mA; $V_{CE}$ = 15 V; $R_L$ = 75 Ω; $f$ = 800 MHz; $T_{amb}$ = 25 °C	47	_	dBm

#### **WARNING**

#### Product and environmental safety - toxic materials

This product contains beryllium oxide. The product is entirely safe provided that the BeO disc is not damaged. All persons who handle, use or dispose of this product should be aware of its nature and of the necessary safety precautions. After use, dispose of as chemical or special waste according to the regulations applying at the location of the user. It must never be thrown out with the general or domestic waste.

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#### LIMITING VALUES

In accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>CBO</sub>	collector-base voltage	open emitter	_	25	V
V <sub>CEO</sub>	collector-emitter voltage	open base	_	18	V
V <sub>EBO</sub>	emitter-base voltage	open collector	_	2	V
I <sub>C</sub>	DC collector current		_	300	mA
P <sub>tot</sub>	total power dissipation	up to T <sub>c</sub> = 110 °C	_	4.5	W
T <sub>stg</sub>	storage temperature		-65	150	°C
Tj	junction temperature		_	200	°C

#### THERMAL RESISTANCE

SYMBOL	PARAMETER	THERMAL RESISTANCE
R <sub>th j-c</sub>	thermal resistance from junction to case	20 K/W

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#### **CHARACTERISTICS**

T<sub>i</sub> = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I <sub>CBO</sub>	collector cut-off current	I <sub>E</sub> = 0; V <sub>CB</sub> = 15 V	_	_	50	μΑ
h <sub>FE</sub>	DC current gain	I <sub>C</sub> = 240 mA; V <sub>CE</sub> = 15 V	25	75	_	
f <sub>T</sub>	transition frequency	I <sub>C</sub> = 240 mA; V <sub>CE</sub> = 15 V; f = 500 MHz	_	4	_	GHz
C <sub>c</sub>	collector capacitance	I <sub>E</sub> = i <sub>e</sub> = 0; V <sub>CB</sub> = 15 V; f = 1 MHz	_	3.8	_	pF
C <sub>e</sub>	emitter capacitance	$I_C = I_C = 0$ ; $V_{EB} = 0.5 \text{ V}$ ; $f = 1 \text{ MHz}$	_	20	_	pF
C <sub>re</sub>	feedback capacitance	I <sub>C</sub> = 0; V <sub>CE</sub> = 15 V; f = 1 MHz	_	2.3	_	pF
C <sub>cs</sub>	collector-stud capacitance	note 1	_	0.8	_	pF
G <sub>UM</sub>	maximum unilateral power gain (note 2)	I <sub>C</sub> = 240 mA; V <sub>CE</sub> = 15 V; f = 800 MHz; T <sub>amb</sub> = 25 °C	_	13	_	dB
Vo	output voltage	note 3	_	1.6	_	V
P <sub>L1</sub>	output power at 1 dB gain compression (see Fig.2)	$I_C$ = 240 mA; $V_{CE}$ = 15 V; $R_L$ = 75 Ω; $T_{amb}$ = 25 °C; measured at f = 800 MHz	_	28	_	dBm
ITO	third order intercept point (see Fig.2)	note 4	_	47	_	dBm

#### **Notes**

- 1. Measured with emitter and base grounded.
- 2.  $G_{UM}$  is the maximum unilateral power gain, assuming  $S_{12}$  is zero and

$$G_{UM} = 10 \log \frac{|S_{21}|^2}{(1-|S_{11}|^2)(1-|S_{22}|^2)} dB.$$

3.  $d_{im} = -60 \text{ dB}$  (see Figs 2 and 7) (DIN 45004B);  $I_C = 240 \text{ mA}$ ;  $V_{CE} = 15 \text{ V}$ ;  $R_L = 75 \Omega$ ;  $T_{amb} = 25 ^{\circ}\text{C}$ ;

$$\begin{split} &V_p = V_o \text{ at } d_{im} = -60 \text{ dB; } f_p = 795.25 \text{ MHz;} \\ &V_q = V_o \ -6 \text{ dB; } f_q = 803.25 \text{ MHz;} \end{split}$$

$$V_{q} = V_{o} -6 \text{ dB}$$
;  $f_{q} = 803.25 \text{ MHz}$ 

$$V_r = V_o -6 dB$$
;  $f_r = 805.25 MHz$ ;

measured at  $f_{(p+q-r)} = 793.25$  MHz.

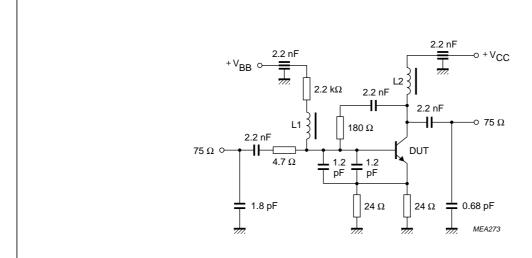
4.  $I_C$  = 240 mA;  $V_{CE}$  = 15 V;  $R_L$  = 75  $\Omega$ ;  $T_{amb}$  = 25  $^{\circ}C$ ;

$$P_p = ITO - 6 dB; f_p = 800 MHz;$$

$$P_q = ITO - 6 dB$$
;  $f_q = 801 MHz$ ;

measured at  $f_{(2q-p)}$  = 802 MHz and at  $f_{(2p-q)}$  = 799 MHz.

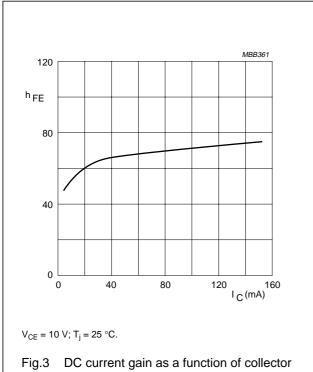
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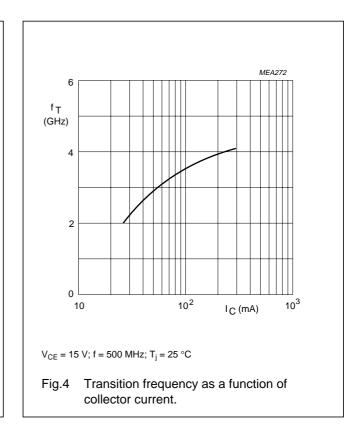
f = 40 to 860 MHz.

 $L1 = L2 = 5 \mu H$  Ferroxcube choke.

Fig.2 Intermodulation distortion MATV test circuit.



current.



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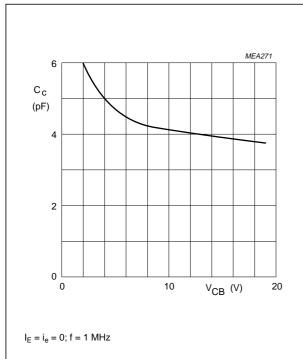
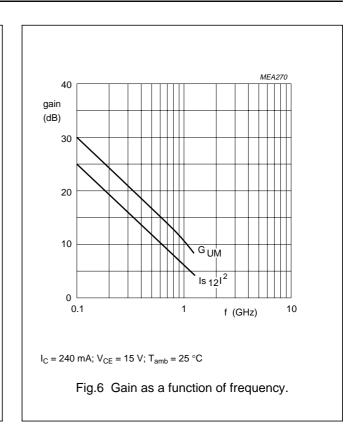
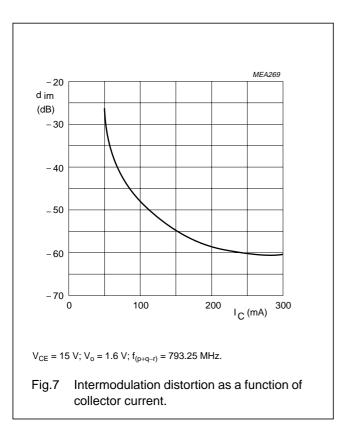
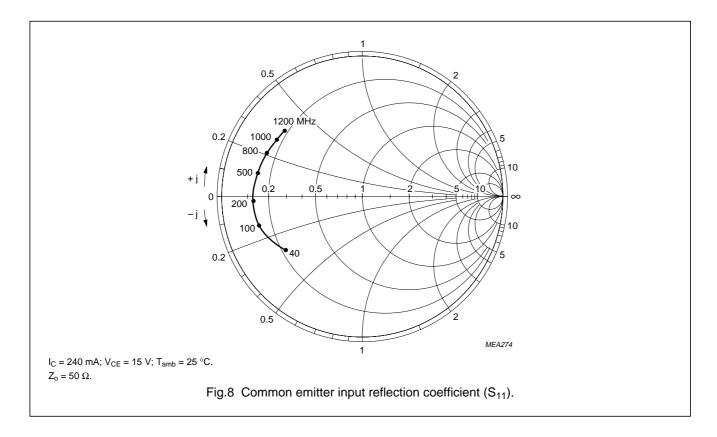


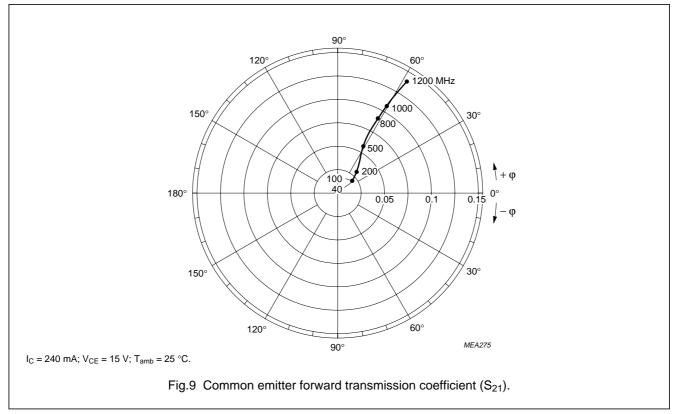
Fig.5 Collector capacitance as a function of collector-base voltage.



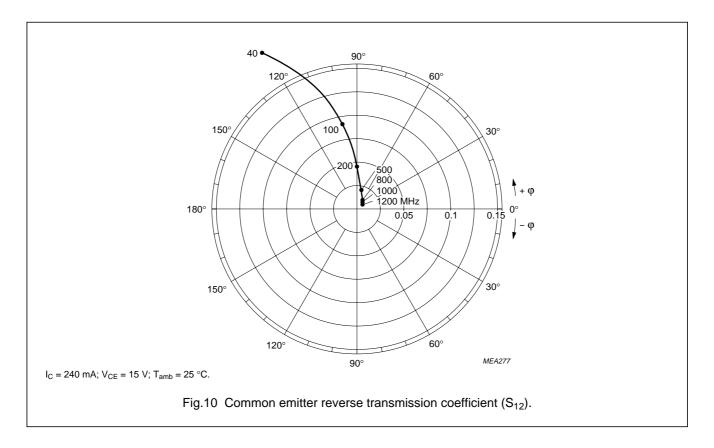


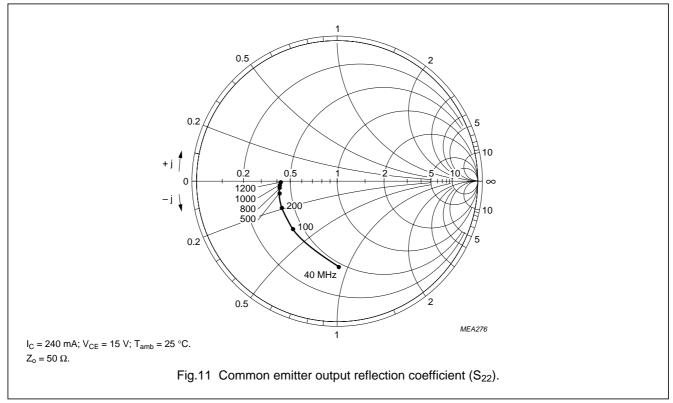
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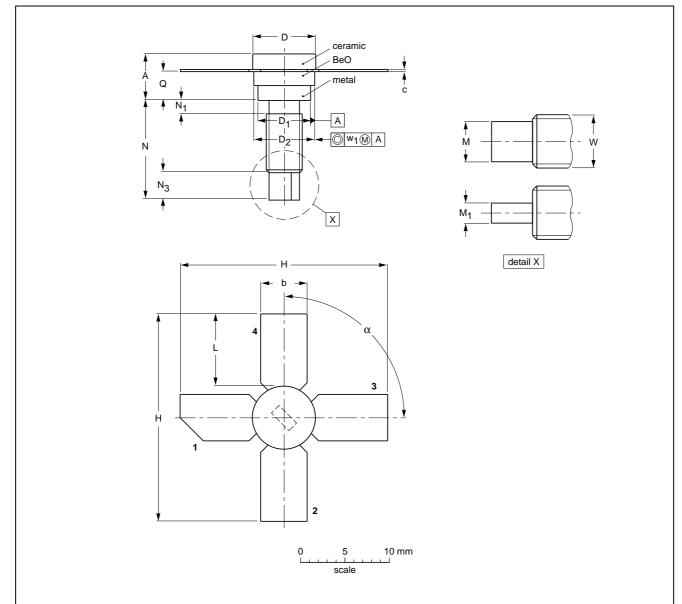


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#### **PACKAGE OUTLINE**

Studded ceramic package; 4 leads

SOT122A



#### DIMENSIONS (millimetre dimensions are derived from the original inch dimensions)

UNIT	Α	b	С	D	D <sub>1</sub>	D <sub>2</sub>	н	L	М1	М	N	N <sub>1</sub> max.	N <sub>3</sub>	Q	w	w <sub>1</sub>	α
mm	5.97 4.74	5.85 5.58	0.18 0.14	7.50 7.23	6.48 6.22	7.24 6.93	27.56 25.78	9.91 9.14	3.18 2.66	1.66 1.39	11.82 11.04	1.02	3.86 2.92	3.38 2.74	8-32 UNC	0.381	90°

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ	PROJECTION	1330E DATE
SOT122A					97-04-18

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#### **DEFINITIONS**

Data Sheet Status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	

#### Limiting values

Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

#### **Application information**

Where application information is given, it is advisory and does not form part of the specification.

#### LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.